ASSOCIATION CONNECTIN	Material Composition © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	tion of the s encompasse	ubstances es all lower	within the manufactu r level materials for w	rer listed i hich the r	item. Note: i nanufacture	f the item is an as r has engineering	ssembly with lower responsibility.
1752-21.1					Form Type Distribute					ials and Mfg Information				
Supplier Inform	ation													
Company name*			Company unique ID				Unique ID Authority				Response Date*			
onsemi											2024-09-21			
Contact Name			Title - Contact				Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requeste	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Date Version Manufacturing Sit		Manufacturing Site		Weight*	UOM	Unit Type	
		NCP361MUTBG		OVP + OCP			2024-09-21		N	MY1		6.95	mg	Each
Manufacturing	Proccess Information	n									1			
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSL		L Rating	Peak Process Body Temperatu		emperatur	ure Max Time at Peak Tempe		ture Numb	per of Reflow Cyc	cles	
Matte Tin (Sn) - annealed CU			U Alloy 1				260 C 30			seconds 3				
Comments														
evel 1 - maximum t	ime at peak temperature o	luring sol	dering is 10-3	0 seconds										
For more information	on regarding material con	position j	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl alate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.23	mg	Supplier	Silicon (Si)	7440-21-3		0.23	mg
Die Attach Epoxy	0.1	mg		Epoxy resin	proprietary data		0.065	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.035	mg
Lead Frame	1.96	mg	Supplier	Silver (Ag)	7440-22-4		0.0392	mg
			Supplier	Iron (Fe)	7439-89-6		0.0431	mg
			Supplier	Copper (Cu)	7440-50-8		1.8777	mg
Mold Compound-Black	3.8	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.304	mg
			Supplier	Carbon Black (C)	1333-86-4		0.019	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.076	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.287	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.114	mg
Plating	0.74	mg	Supplier	Tin (Sn)	7440-31-5		0.74	mg
Wire Bond - Au	0.12	mg	Supplier	Gold (Au)	7440-57-5		0.12	mg